

### High performance CMOS quad operational amplifier

#### **Features**

- Output voltage can swing to ground
- Excellent phase margin on capacitive loads
- Gain bandwidth product: 3.5 MHz
- Unity gain stable
- Two input offset voltage selections

### **Description**

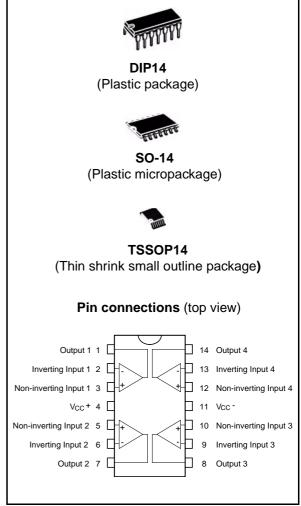
The TS274 devices are low cost, quad operational amplifiers designed to operate with single or dual supplies. These operational amplifiers use the ST silicon gate CMOS process giving an excellent consumption-speed ratio. These series are ideally suited for low consumption applications.

Three power consumptions are available thus offering the best consumption-speed ratio for your application:

- I<sub>CC</sub> = 10 µA/amp: TS27L4 (very low power)
- I<sub>CC</sub> = 150 µA/amp: TS27M4 (low power)
- I<sub>CC</sub> = 1 mA/amp: TS274 (standard)

These CMOS amplifiers offer very high input impedance and extremely low input currents. The major advantage versus JFET devices is the very low input currents drift with temperature (see *Figure 5 on page 6*).

For enhanced features of TS274, in particular rail-to-rail capability and low offset voltage, two new



families, TSV91x and TSV99x will better suit low voltage applications.

Table 1. Enhanced related families

Part number	V <sub>CC</sub> range (V)	Rail-to- rail I/O	V <sub>io</sub> max (mV)	I <sub>ib</sub> max (pA)	A <sub>vd</sub> min (dB)	I <sub>CC</sub> max (mA)	GBP typ (MHz)	SR typ (V/µs)	Packages
TSV914	2.5 - 5.5	I/O	1.5/4.5	10	80	1.1	8	4.5	SO-14, TSSOP14
TSV994	2.5 - 5.5	I/O	1.5/4.5	10	80	1.1	20 (G ≥3)	10	SO-14, TSSOP14

February 2008 Rev 3 1/14

### 1 Absolute maximum ratings and operating conditions

Table 2. Absolute maximum ratings (AMR)

Symbol	Parameter	TS274C/AC	TS274I/AI	Unit
V <sub>CC</sub> <sup>+</sup>	Supply voltage (1)	1	V	
V <sub>id</sub>	Differential input voltage (2)	±1	8	V
V <sub>in</sub>	Input voltage (3)	-0.3 1	o 18	V
Io	Output current for V <sub>CC</sub> <sup>+</sup> ≥ 15V	±3	30	mA
I <sub>in</sub>	Input current	±	5	mA
T <sub>oper</sub>	Operating free-air temperature range	0 to +70	-40 to +125	°C
T <sub>stg</sub>	Storage temperature range	-65 to	°C	
R <sub>thja</sub>	Thermal resistance junction to ambient <sup>(4)</sup> SO-14 TSSOP14 DIP14	10 10 8	°C/W	
R <sub>thjc</sub>	Thermal resistance junction to case SO-14 TSSOP14 DIP14	31 32 33		°C/W
	HBM: human body model <sup>(5)</sup>	500		V
ESD	MM: machine model <sup>(6)</sup>	10	V	
	CDM: charged device model <sup>(7)</sup>	80	00	V

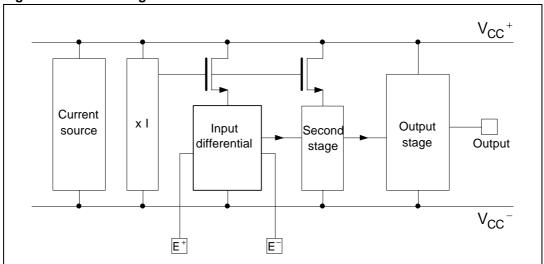
- 1. All values, except differential voltage are with respect to network ground terminal.
- 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
- The magnitude of the input and the output voltages must never exceed the magnitude of the positive supply voltage.
- 4. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
- 5. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a  $1.5k\Omega$  resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 6. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5Ω). This is done for all couples of connected pin combinations while the other pins are floating.
- Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 3. Operating conditions

Symbol	Parameter	Value	Unit
V <sub>CC</sub> <sup>+</sup>	Supply voltage	3 to 16	V
V <sub>icm</sub>	Common mode input voltage range	0 to V <sub>CC</sub> <sup>+</sup> - 1.5	V
T <sub>oper</sub>	Operating free-air temperature range TS274C TS274I	0 to 70 -40 to 125	°C

# 2 Block diagram and circuit schematics

Figure 1. Block diagram



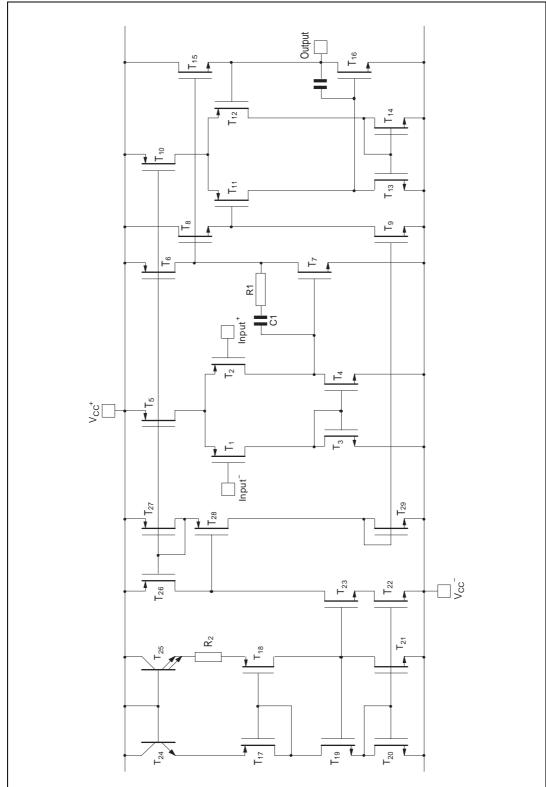


Figure 2. Schematic diagram (for 1/4 TS274)

## 3 Electrical characteristics

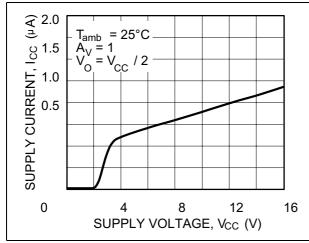
Table 4.  $V_{CC}^+ = +10V$ ,  $V_{CC}^- = 0V$ ,  $T_{amb} = +25$ °C (unless otherwise specified)

0	Banana (an	O a malificia na	TS	5274C/	AC	Т	S274I/	ΆΙ	Unit
Symbol	Parameter	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
V <sub>io</sub>	Input offset voltage	$V_0 = 1.4V$ , $V_{ic} = 0V$ TS274C/I TS274AC/AI		1.1 0.9	10 5		1.1 0.9	10 5	mV
V 10	input onset voltage	$T_{min} \le T_{amb} \le T_{max}$ TS274C/I TS274AC/AI			12 6.5			12 6.5	mV
DV <sub>io</sub>	Input offset voltage drift			2			2		μV/°C
I <sub>io</sub>	Input offset current (1)	$V_{ic} = 5V, V_o = 5V$ $T_{min} \le T_{amb} \le T_{max}$		1	100		1	200	pA
l <sub>ib</sub>	Input bias current (1)	$V_{ic} = 5V, V_o = 5V$ $T_{min} \le T_{amb} \le T_{max}$		1	150		1	300	рА
V <sub>OH</sub>	High level output voltage	$V_{id} = 100 \text{mV}, R_L = 10 \text{k}\Omega$ $T_{min} \le T_{amb} \le T_{max}$	8.2 8.1	8.4		8.2 8	8.4		V
V <sub>OL</sub>	Low level output voltage	V <sub>id</sub> = -100mV			50			50	mV
A <sub>vd</sub>	Large signal voltage gain	$V_{iC} = 5V$ , $R_L = 10k\Omega$ , $V_o = 1V$ to $6V$ $T_{min} \le T_{amb} \le T_{max}$	10 7	15		10 6	15		V/mV
GBP	Gain bandwidth product	$A_v = 40$ dB, $R_L = 10$ k $\Omega$ , $C_L = 100$ pF, $f_{in} = 100$ kHz		3.5			3.5		MHz
CMR	Common mode rejection ratio	$V_{ic} = 1V \text{ to } 7.4V, V_0 = 1.4V$	65	80		65	80		dB
SVR	Supply voltage rejection ratio	$V_{CC}^{+} = 5V \text{ to } 10V, V_{o} = 1.4V$	60	70		60	70		dB
Icc	Supply current (per amplifier)	$A_V = 1$ , no load, $V_0 = 5V$ $T_{min} \le T_{amb} \le T_{max}$		1000	1500 1600		1000	1500 1700	μΑ
Io	Output short circuit current	$V_0 = 0V, V_{id} = 100mV$		60			60		mA
I <sub>sink</sub>	Output sink current	$V_0 = V_{CC}$ , $V_{id} = -100$ mV		45			45		mA
SR	Slew rate at unity gain	$R_L = 10k\Omega$ $C_L = 100pF$ , $V_{in} = 3 \text{ to } 7V$		5.5			5.5		V/µs
φm	Phase margin at unity gain	$A_V = 40$ dB, $R_L = 10$ k $\Omega$ , $C_L = 100$ pF		40			40		Degrees
K <sub>OV</sub>	Overshoot factor			30			30		%
e <sub>n</sub>	Equivalent input noise voltage	$f = 1kHz, R_s = 100\Omega$		30			30		nV/√Hz
V <sub>01</sub> /V <sub>02</sub>	Channel separation			120			120		dB

<sup>1.</sup> Maximum values including unavoidable inaccuracies of the industrial test.

Electrical characteristics TS274

Figure 3. Supply current (each amplifier) vs. Figure 4. High level output voltage vs. high supply voltage level output current



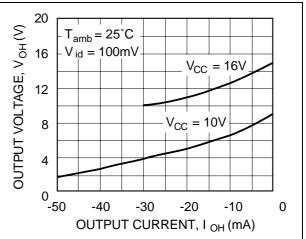


Figure 5. Input bias current vs. free-air temperature

TEMPERATURE, T amb (°C)

Figure 6. Low level output voltage vs. low level output current

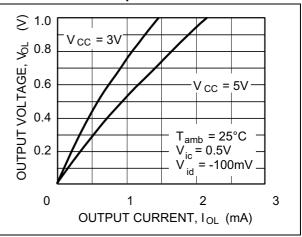


Figure 7. High level output voltage vs. high level output current

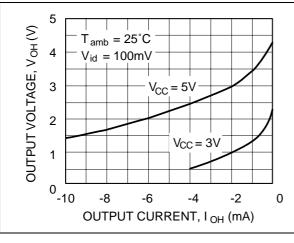


Figure 8. Low level output voltage vs. low level output current

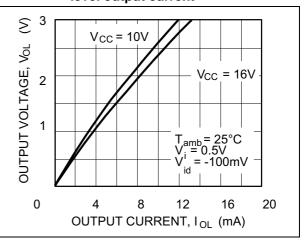


Figure 9. Open loop frequency response and Figure 10. Phase margin vs. capacitive load phase shift

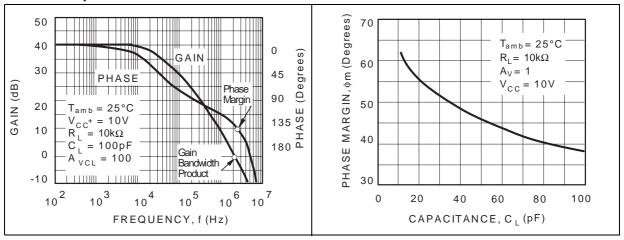


Figure 11. Gain bandwidth product vs. supply Figure 12. Slew rate vs. supply voltage voltage

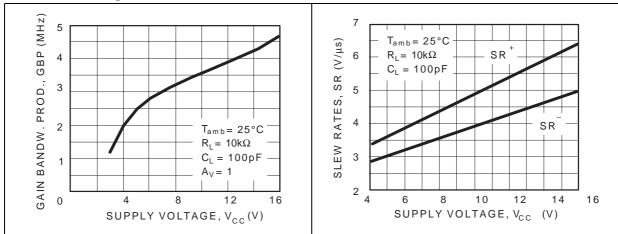
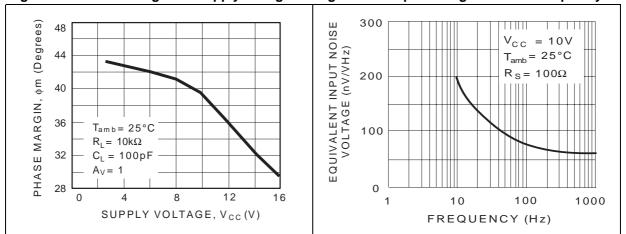


Figure 13. Phase margin vs. supply voltage Figure 14. Input voltage noise vs. frequency



Macromodel TS274

### 4 Macromodel

### 4.1 Important note concerning this macromodel

Please consider the following remarks before using this macromodel.

- All models are a trade-off between accuracy and complexity (i.e. simulation time).
- Macromodels are not a substitute to breadboarding; rather, they confirm the validity of a design approach and help to select surrounding component values.
- A macromodel emulates the nominal performance of a typical device within specified operating conditions (temperature, supply voltage, for example). Thus the macromodel is often not as exhaustive as the datasheet, its purpose is to illustrate the main parameters of the product.

Data derived from macromodels used outside of the specified conditions ( $V_{CC}$ , temperature, for example) or even worse, outside of the device operating conditions ( $V_{CC}$ ,  $V_{icm}$ , for example), is not reliable in any way.

#### 4.2 Macromodel code

```
.SUBCKT TS27X 1 2 3 4 5
*** INP- = 1, INP+ = 2, OUT = 3 VDD=4 VSS = 5
*** TYPE = TS271/TS272/TS274
.MODEL MDTH D IS=1E-8 KF=2.664E-16 CJO=10F
***INPUT STAGE
CIP 2 5 1E-12
CIN 1 5 1E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
RIP 10 11 8
RIN 15 16 8
RIS 11 15 223.84
CPS 11 15 1E-9
DIP 11 120 MDTH 400E-12
DIN 15 140 MDTH 400E-12
RDEG1 12 120 4400
RDEG2 14 140 4400
VOFP 12 13 DC 0
VOFN 13 14 DC 0
IPOL 13 5 38E-6
***ICC
DICC1 4 31 MDTH 400E-12
DICC2 31 32 MDTH 400E-12
DICC3 32 33 MDTH 400E-12
DICC4 33 34 MDTH 400E-12
RICC 34 5 20E3
ICC 4 5 600E-6
***COMMON MODE INPUT LIMITATION
DINN 17 13 MDTH 400E-12
VIN 17 5 DC -0.1
```

TS274 Macromodel

```
DINR 15 18 MDTH 400E-12
VIP 4 18 DC 2.2
***GM1 STAGE
FGM1P 119 5 VOFP 1
FGM1N 119 5 VOFN 1
RAP 119 4 1E6
RAN 119 5 1E6
***GM2 STAGE
G2P 19 5 119 5 4E-4
G2N 19 5 119 4 4E-4
R2P 19 4 450E3
R2N 19 5 450E3
***COMPENSATION
CC 19 119 7p
***BUFFER
EBUF 20 5 19 5 1
***SHORT-CIRCUIT LIMITATIONS( ISINK, ISOURCE)
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 910
VIPM 28 4 DC 50
HONM 21 27 VOUT 1222
VINM 5 27 DC 50
VOUT 3 23 DC 0
***VOH, VOL DEFINITIONS
DOP 19 25 MDTH 400E-12
VOP 4 25 2.5
DON 24 19 MDTH 400E-12
VON 24 5 0.92
***OUTPUT RESISTOR
ROUT 23 20 10
```

**577** 

.ENDS

**Package information TS274** 

#### **Package information** 5

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

#### 5.1 **DIP14** package information

Figure 15. DIP14 package mechanical drawing

Table 5. DIP14 package mechanical data

Ref.		Millimeters Inch		Inches		
Rei.	Min.	Тур.	Max.	Min.	Тур.	Max.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

TS274 Package information

## 5.2 SO-14 package information

Figure 16. SO-14 package mechanical drawing

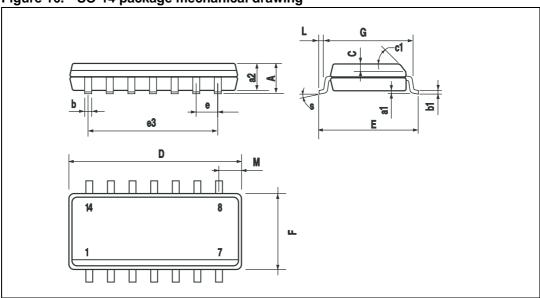


Table 6. SO-14 package mechanical data

			Dime	nsions			
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.75			0.068	
a1	0.1		0.2	0.003		0.007	
a2			1.65			0.064	
b	0.35		0.46	0.013		0.018	
b1	0.19		0.25	0.007		0.010	
С		0.5			0.019		
c1			45°	(typ.)	•		
D	8.55		8.75	0.336		0.344	
Е	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		7.62			0.300		
F	3.8		4.0	0.149		0.157	
G	4.6		5.3	0.181		0.208	
L	0.5		1.27	0.019		0.050	
М			0.68			0.026	
S		1	8° (r	max.)	·	•	

Package information TS274

## 5.3 TSSOP14 package information

Figure 17. TSSOP14 package mechanical drawing

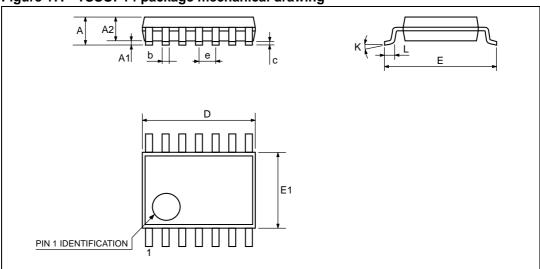


Figure 18. TSSOP14 package mechanical data

			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
Е	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L1	0.45	0.60	0.75	0.018	0.024	0.030

TS274 Ordering information

# 6 Ordering information

Table 7. Order codes

Order code	Temperature range	Package	Packing	Marking
TS274CD TS274CDT		Tube or		274C
TS274ACD TS274ACDT		SO-14	Tape & reel	274AC
TS274CN	0°C, +70°C	DIP14	Tube	TS274CN
TS274ACN		DIF 14	Tube	TS274ACN
TS274CPT		TSSOP14	Tape & reel	274C
TS274ACPT		1330F14	Tape & Teel	274AC
TS274ID TS274IDT		SO-14	Tube or	2741
TS274AID TS274AIDT		30-14	Tape & reel	274AI
TS274IN	-40°C, +125°C	DIP14	Tube	TS274IN
TS274AIN		DIF 14	Tube	TS274AIN
TS274IPT		TSSOP14	Tano 8 rool	2741
TS274AIPT		1330F14	Tape & reel	274AI

## 7 Revision history

Table 8. Document revision history

Date	Revision	Changes
19-Nov-2001	1	Initial release.
07-Apr-2006	2	ESD protection inserted in <i>Table 2. on page 2.</i> Thermal resistance junction to case information added see <i>Table 2. on page 2.</i> Macromodel insertion in <i>Section 4 on page 8.</i>
01-Feb-2008	3	Added information on enhanced related families of devices on cover page. Removed TS274B version in AMR table and in order codes table.

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477